



Specification of MEMS Microphone

(RoHS Compliance & Halogen Free)

Customer Name:

Customer Model:

GoerTek Model: S15OB381-081

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1 Security Warning

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2 Publication History

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1.0	New Design	2019.07.14	Samual	Daniel



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1 Introduction:

MEMS MIC which is able to endure reflow temperature up to 260 $^{\circ}\mathrm{C}$ for 50 seconds can be used in SMT process. It is widely used in telecommunication and electronics device such as mobile phone, MP3, PDAs etc.

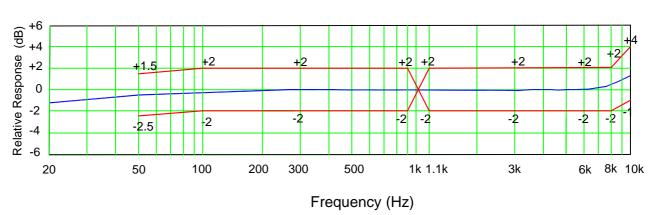
2 Test Condition (Vs=2.7V, L=50cm)

StandardConditions (As IEC 60268-4)	Temperature	Humidity	Air pressure
Environment Conditions	+15℃~+35℃	25%R.H.∼75%R.H.	86kPa \sim 106kPa
Basic Test Conditions	+20°C ± 2°C	60%R.H.∼70%R.H.	86kPa \sim 106kPa

3 Acoustic and Electrical Characteristics

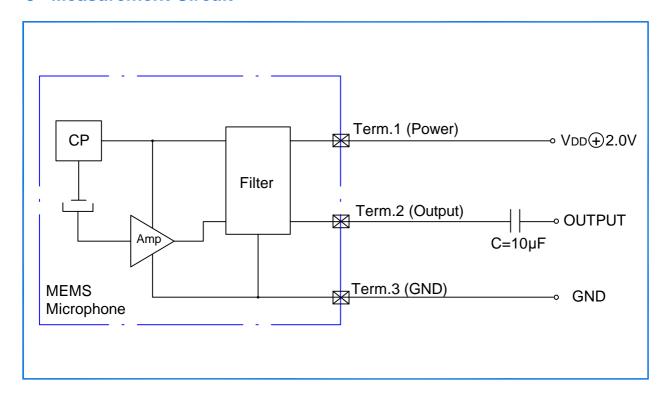
Item	Symbol	Test Conditions	Min	Тур	Max	Unit
Operating Voltage Range	Vs		1.5		3.6	V
Current Consumption	Ι	Vs=2.7V			150	μA
Sensitivity	S	f=1kHz, Pin=1Pa	-39	-38	-37	dBV
S/N Ratio	SNR	f=1kHz, Pin=1Pa A-Weighted Curve		63		dB
Total Harmonic Distortion	THD	94dB SPL@1kHz			1	%
Total Harmonic Distortion		110dB SPL@1kHz			2	%
Acoustic Overload Point	AOP	10%THD@1kHz		128		dB SPL
Power Supply Rejection	PSR	100mVpp square wave@217Hz Vs=2.7V, A-Weighted		-96		dBV
Power Supply Rejection Ration	PSRR	200mVpp sinewave@1k Hz, Vs=2.7V,Rload>2Kohm		68		dB
Output Impedance	Zout	f=1kHz, Pin=1Pa			400	Ω
Decreasing Voltage Characteristic	Δs	f=1kHz, Pin=1Pa Vs=3.61.5V	No Change			
Directivity	D(θ)		Omnidirectional			

4 Frequency Response Curve and Limits

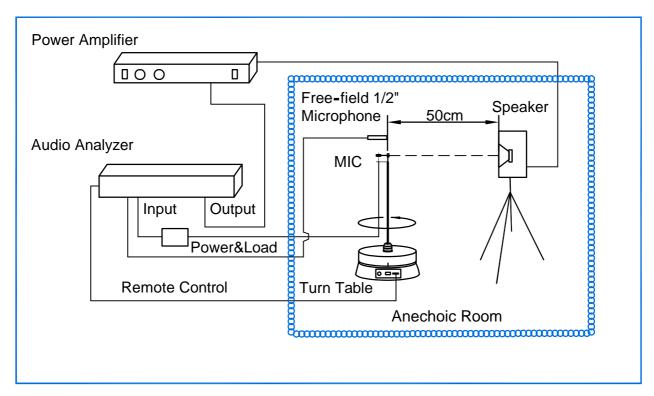




5 Measurement Circuit



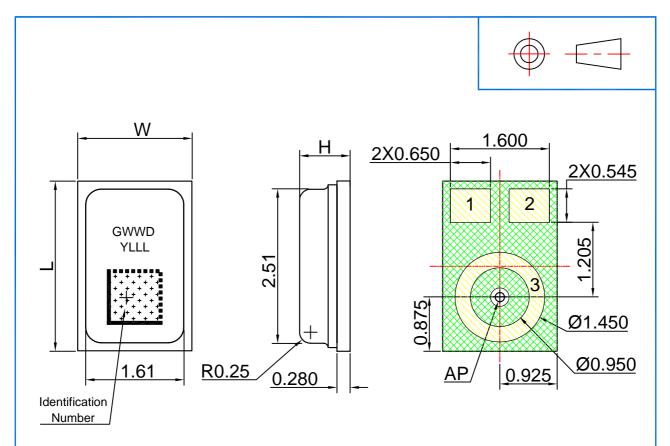
6 Test Setup Drawing





7 Mechanical Characteristics

7.1 Appearance Drawing (Unit: mm)



Top View

Pin#	Function
1	Power
2	Output
3	GND

Bottom View

Item	Dimension	Tolerance	Units
Length(L)	2.75	±0.10	mm
Width(W)	1.85	±0.10	mm
Height(H)	0.90	±0.10	mm
Acoustic Port(AP)	Ø0.15	±0.05	mm

Note: 1. Tolerance ±0.1 mm unless otherwise specified.

2. Identification Number Convention: Job Identification Number.

Identification Number

G: GoerTek

www:Week D:Day

Y:Year LLL: Serial Number



2D Code

7.2 Weight

The weight of the MIC is Less than 0.02g.



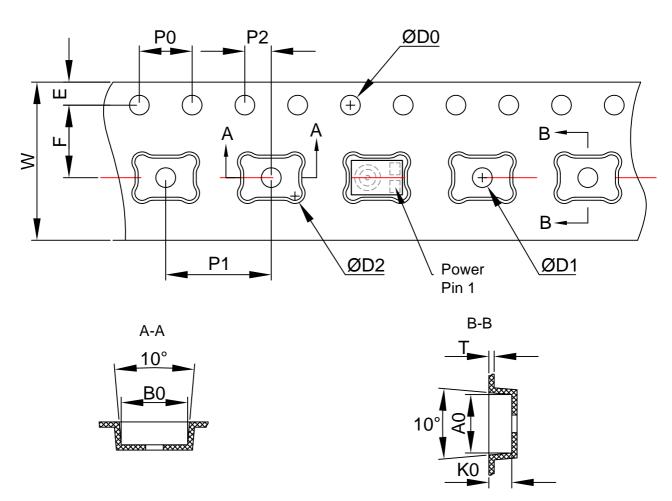
8 Reliability Test

8.1 Vibration Test	To be no interference in operation after vibrations, 4 cycles, from 20 to 2,000Hz in each direction(X,Y,Z), 48 minutes, using peak acceleration of 20g, sensitivity should vary within ± 3 dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15^{\circ}$ C $\pm 35^{\circ}$ C, R.H.25% $\pm 75^{\circ}$ C)
8.2 Drop Test	To be no interference in operation after dropped to marble 12 times from 1.5 meter height in state of JIG,JIG weight of 150g, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15 $^{\circ}$ C+35 $^{\circ}$ C, R.H.25 $^{\circ}$ C75%)
8.3 Temperature Test	a) After exposure at +125 °C for 200 hours, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15 °C ~+35 °C, R.H.25 % ~75%) b) After exposure at -40 °C for 200 hours, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15 °C ~+35 °C, R.H.25 % ~75%)
8.4 Humidity Test	After exposure at +85 $^{\circ}$ C and 85% relative humidity for 200 hours, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15 $^{\circ}$ C +35 $^{\circ}$ C, R.H.25 $^{\circ}$ C 75%)
8.5 Mechanical Shock Test	Then subject samples to three one-half sine shock pulses (3000 g for 0.3 milliseconds) in each direction (for six axes in total) along each of the three mutually perpendicular axes for a total of 18 shocks, sensitivity should vary within ± 3 dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15^{\circ}$ C $\pm 35^{\circ}$ C, R.H.25% $\pm 75^{\circ}$ C)
8.6 Thermal Shock Test	After exposure at -40 $^{\circ}$ C for 30 minutes, at +125 $^{\circ}$ C for 30 minutes (change time 20 seconds) 32 cycles, sensitivity should vary within ±3dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at +15 $^{\circ}$ C $^{\circ}$ +35 $^{\circ}$ C, R.H.25 $^{\circ}$ C $^{\circ}$ 75%)
8.7 Reflow Test	Adopt the reflow curve of item 12.3, after three reflows, sensitivity should vary within $\pm 2dB$ from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15\%$ +35%, R.H.25% $\pm 75\%$)
8.8 Electrostatic Discharge Test	Under C=150pF, R=330ohm. Tested to ± 2 kV contact to I/O terminals.10 times. Grounding. Sensitivity should vary within ± 3 dB from initial sensitivity. (The measurement to be done after 2 hours of conditioning at $\pm 15^{\circ}$ C $\pm 435^{\circ}$ C, R.H.25% $\pm 75^{\circ}$ C)



9 Package

9.1 Tape Specification



The Dimensions as Follows:

ITEM	W	E	F	ØD0	ØD1
DIM(mm)	12.0±0.30	1.75±0.10	5.5±0.05	1.50 ^{+0.10}	1.00 ^{+0.10}
ITEM	P0	10P0	P1	A0	В0
DIM(mm)	4.00±0.10	40.00±0.20	8.00±0.10	3.00±0.05	2.05±0.05
ITEM	K0	P2	Т	ØD2	
DIM(mm)	1.10±0.10	2.00±0.05	0.30±0.05	0.50±0.10	

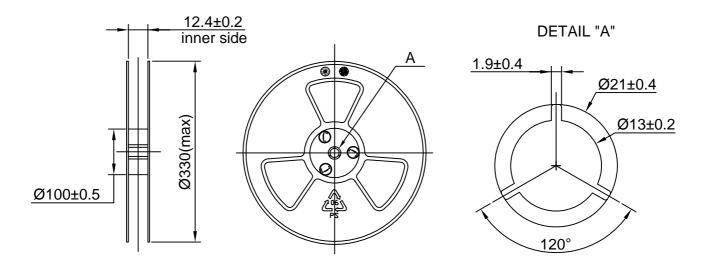


9.2 Reel Dimension

7" reel for sample stage

13" reel will be provided for the mass production stage

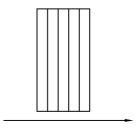
The following is 13" reel dimensions (unit:mm)



9.3 The Content of Box(13" reel)

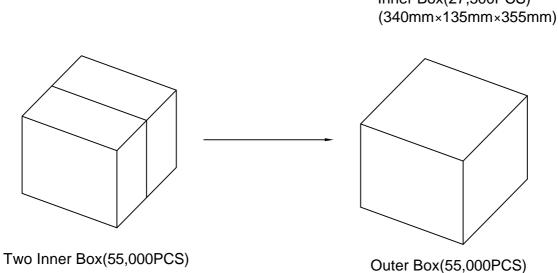


Packing (5,500PCS)



Inner Box(27,500PCS)

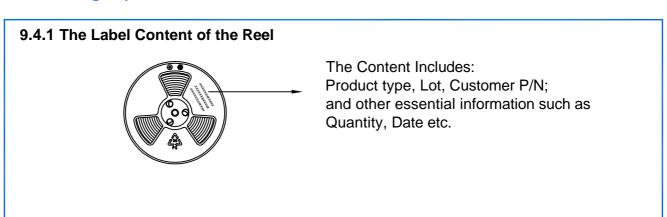
(370mm×300mm×390mm)

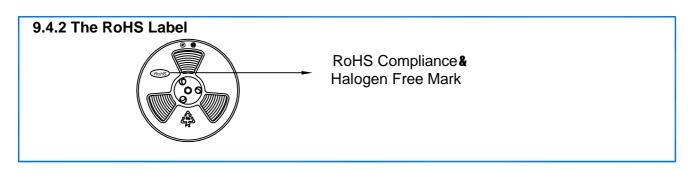


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9.4 Packing Explain





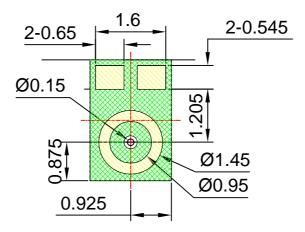
10 Storage and Transportation

- 10.1 Keep MEMS MIC in warehouse with less than 75% humidity and without sudden temperature change, acid air, any other harmful air or strong magnetic field. Recommend storage period no more than 1 year and floor life(out of bag) at factory no more than 4 weeks.
- 10.2 The MEMS MIC with normal pack can be transported by ordinary conveyances. Please protect products against moist, shock, sunburn and pressure during transportation.
- 10.3 Storage Temperature Range : $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$ (Microphone units with package)
- 10.4 Operating Temperature Range: -40°C∼+100°C

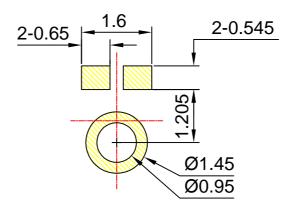


11 Land Pattern Recommendation

11.1 The Pattern of MIC Pad(Unit:mm)



11.2 Recommended Soldering Surface Land Pattern(Unit:mm)



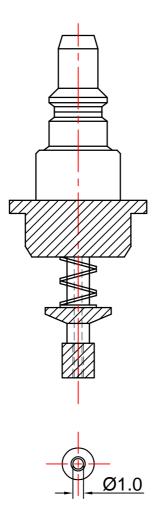


12 Soldering Recommendation

12.1 Soldering Machine Condition

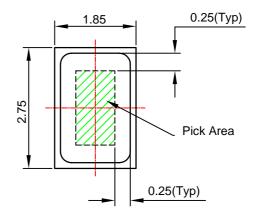
Temperature Control	8 zones
Heater Type	Hot Air
Solder Type	Lead-free

12.2 The Drawing and Dimension of Nozzle



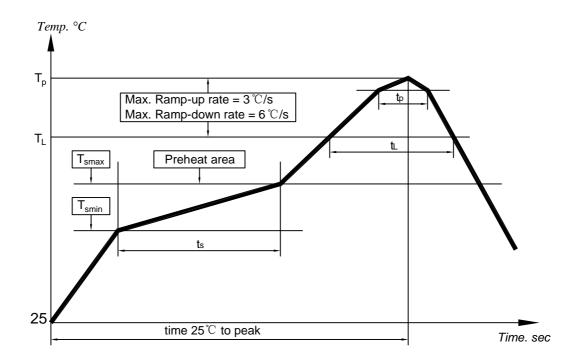
Inside Diameter: Ø1.0mm;

Please don't vacuum over the acoustic port directly. Please don't blow the acoustic port directly.





12.3 Reflow Profile



Key Features of The Profile:

Average Ramp-up rate(T _{smax} to T _p)	3℃/s max.
Preheat : Temperature $Min(T_{smin})$ Temperature $Max(T_{smax})$ Time $(T_{smin}$ to $T_{smax})(t_s)$	150℃ 200℃ 60~180s
Time maintained above : $Tempreature(T_L) \\ Time(t_L)$	217℃ 60~150s
Peak Temperature(T _p)	260℃
Time within $5^{\circ}\!$	30~40s
Ramp-down rate(T _p to T _{smax})	6℃/s max
Time 25℃ to Peak Temperature	8min max

When MEMS MIC is soldered on PCB, the reflow profile is set according to solder paste and the thickness of PCB etc.



12.4 Rework

- (1) 250° C \sim 270 $^{\circ}$ C, maximum 30 sec, Peak temperature 330 $^{\circ}$ C.
- (2) Wind speed: 15L/m.
- (3) It is very important not to put a heatgun over the acoustic port of the microphone.

13 Cautions

13.1 Board Wash Restrictions

It is very important not to board wash the PCBA after reflow process, otherwise this could damage the microphone.

13.2 Vacuum Restrictions

It is very important not to put a vacuum over the acoustic port of the microphone. otherwise this could damage the microphone.

13.3 Ultrasonic Restrictions

It is very important not to use ultrasonic process. otherwise this could damage the microphone.

13.4 Air Blow Restrictions

It is very important not tnot o use air gun near the port hloe of the microphone, otherwise this could damage the microphone.

14 Output Inspection Standard

Output inspection standard is executed according to <<ISO2859-1:1999>>.

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